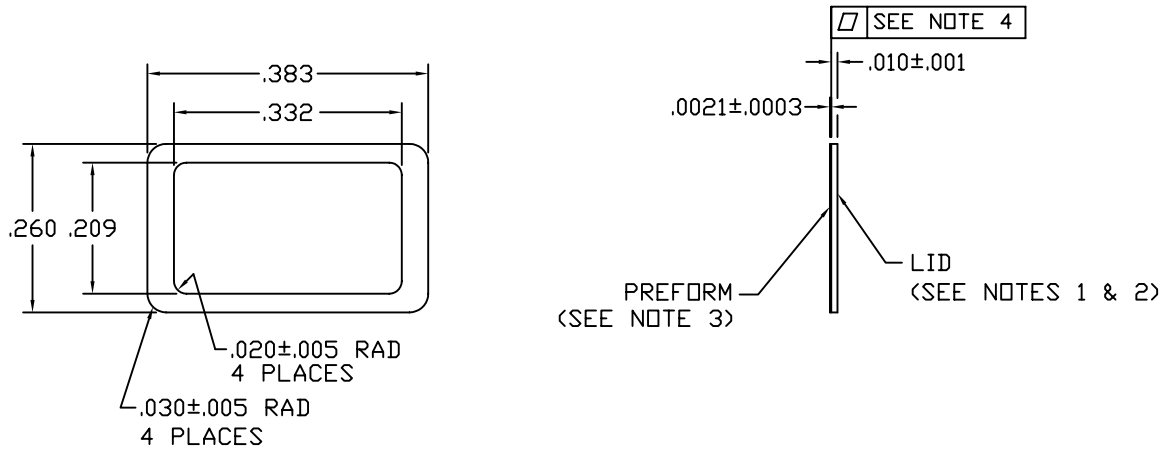


# SSM P/N CL382602



**NOTES**

1. MAT'L : KOVAR OR ALLOY 42
2. PLATING : 1st LAYER 50/350 MICROINCHES NI  
2nd LAYER Au  
3rd LAYER 50/350 MICROINCHES NI  
4th LAYER 25 MICROINCHES MINIMUM Au

NOTES : TOTAL NICKEL LAYERS SHALL NOT EXCEED 450 MICROINCHES AND THE SUM OF BOTH GOLD LAYERS SHALL BE 50 MICROINCHES MINIMUM.

3. PREFORM - 80% ±1% Au  
20% Sn
4. FLATNESS : ONE MIL (.001) MAXIMUM PER 1/2" T.I.R
5. TOLERANCES TO BE (XXX) 3 PLACES ±.003 UNLESS OTHERWISE NOTED

**CONTROLLED 4-10-03**

DESIGN	BW	08/03 89	DESCRIPTION Hi-Rel Combo Lid
APPROD	VG	03/08 00	PART NAME CL382602
Spectrum Semiconductor Materials, Inc. 2027 O'Toole Ave San Jose, CA 95131 PH: (408) 435-5555 Fx: (408)435-8226			SCALE 4 = 1 DEPT
MFG: Semi-Alloys			PART No. HRC-386-21-25MT-100MNI-S

